

ABSTRACT OF THE DISCLOSURE

An electronic control device includes first and second ceramic substrates housed in a case. The first ceramic substrate has electronic components including a semiconductor component mounted on its surface. The second ceramic substrate is fixed to the top face of the semiconductor component. The second ceramic substrate has electronic components mounted on its bottom surface. A connecting member having wiring members is arranged between the first and the second ceramic substrates. The first ceramic substrate is electrically connected with the second ceramic substrate via the wiring members.